Declaration and Power of Attorney United States Patent Application

UNITED STATES
Patents and Design Patents
Sole & Joint Inventors
Convention & Non-convention
PCT & Non-PCT
This form cannot be amended, alterer
or changed after it is signed
(For use only for inventors who
understand the English language.)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor(if only one name is listed below) or an original, first and joint inventor(if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

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(check one)	is attached here								
	□ was filed as U.S. Application No on and (if applicable) was amended on								
		T International Application No	on	and (if applicable) was amended under					
			ation, including the claims, as amende ty as defined in Title 37, Code of Fede	d by any amendment referred to above. eral Regulations, §1.56.					
				d PCT application(s) for patent or inventor's certificat					
				of America listed in this Declaration. I have also a filing date before that of the application(s) on which					
priority is clai	imed: T Application No.	T.C	Filing Date	District Chinad (was/as)					
roteigh/rC	1 Application No.	Country	rining Date	Priority Claimed? (yes/no)					
2001-05	54400	JAPAN	FEBRUARY 28, 200	1 Yes					
I hereby clain	n the benefit under Title 3	5 United States Code \$20 or \$365(c)	of any United States application and	PCT international application designating the United					
				on is not disclosed in the prior United States application					
				2, I acknowledge the duty to disclose information which					
	patentability as defined in CT international filing date		s, §1.56 which became available between	en the filing date of the prior application and the					
U.S. Applic		Filing Date	Status (patented/pending/aband	oned?)					
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	n priority benefits under T	itle 35 United States Code §119(e) of	any U.S. provisional application(s) lis	sted below:					
	ional Application No.	Filing Date							
grant Spiner									
		·····							
Weilarher (20	0,531), Herbert M. Hanega	n (25,682), Dale Lischer (28,438), Fre		Trademark Office connected therewith: Robert G. Lunsford, III (29,405), Michael A. Makuch (32,263), Brandon S. Boss (46,567).					
	espondence to: SMITH, G irect all phone calls to (20)		M Street N.W. (Suite 800), Washington	a, D.C. 20036. All facsimiles may be sent to (202)					
be true; and f under Section	urther that these statemen	ts were made with the knowledge that nited States Code and that such willfu	rue and that all statements made on inf t willful false statements and the like s al false statements may jeopardize the	o made are punishable by fine or imprisonment, or bo					
	of sole or first invent			Citizenship : Japan					
Residence	(city, state, country):	Osaka-shi, Osaka, Japan		_					
Post office	address: c/o KYOCI	ERA MITA CORPORATION,	2-28, Tamatsukuri 1-chome, Cl	nuo-ku, Osaka-shi, Osaka 540-8585, Japan					
			1						
Signature:	Jun A:	Zuma	Date: 1/21/2002						
Signature:			Date:						
Full name	of second joint inven	tor, if any: Ayako YASHIMA		Citizenship: Japan					
Residence	(city, state, country):	Osaka-shi, Osaka, Japan							
Post office	address: c/o KYOCI	ERA MITA CORPORATION,	2-28, Tamatsukuri 1-chome, Cl	nuo-ku, Osaka-shi, Osaka 540-8585, Japan					
Signature:	Ayako	Yashima	Date: 1/21/2002 ttached Supplemental Sheet(s).	2					
Addition	nal inventors and/or p	prior applications are listed in a	ttached Supplemental Sheet(s).						
SGR/BDW	٧Y	**							

Supplemental Sheet to U.S. Declaration and Power of Attorney (SGR/BDWY-1 supp.)

Additional Inventor(s):						
Full name of third joint inventor, it Residence (city, state, country):	Osaka-shi, Osaka, Japan		Citizenship: Japan 1, Osaka-shi, Osaka 540-8585, Japan			
1 ost office address. C/O K 1 OCEP	A MITA CONTONATION, 2-	-20, Tamatsukum 1-Chome, Chuo-kt	i, Osaka-sili, Osaka 340-0303, Japai			
Signature: Yukimasa	WATANABE D	Date: 1/21/2002	whater continue			
Full name of fourth joint inventor Residence (city, state, country): O Post office address: c/o KYOCEF	Osaka-shi, Osaka, Japan	-28, Tamatsukuri 1-chome, Chuo-ki	Citizenship: Japar 1, Osaka-shi, Osaka 540-8585, Japar			
Signature: <u>Keisuke</u>	<i>0BA</i>	Date: 1/32/2002				
*	Osaka-shi, Osaka, Japan RA MITA CORPORATION, 2-	-28, Tamatsukuri 1-chome, Chuo-ku / / 8 / 2°°2 Jate: Jac / 6/ // HF.	Citizenship: Japan 1, Osaka-shi, Osaka 540-8585, Japan			
Full name of sixth joint inventor, Residence (city, state, country):	if any: Takashi NAGASHIM. Osaka-shi, Osaka, Japan RA MITA CORPORATION, 2- mashima D	A	Citizenship: Japan u, Osaka-shi, Osaka 540-8585, Japan			
Foreign/PCT Application No.	Country	Filing Date	Priority Claimed? (yes/no)			
2001-063368	Japan	March 7, 2001	Yes			
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Additional U.S. Applications:						
U.S. Application No.	Filing Date	Status (patented/pending/aban	doned?)			
Additional Provisional U.S. Appl	ications:					
U.S. Provisional Applie	cation No.	Filing Date	Filing Date			